# USB Host Charger Identification/ Adapter Emulators

### **General Description**

The MAX14600–MAX14605 and MAX14618 are thirdgeneration USB 2.0 host charger identification devices that combine USB Hi-Speed analog switches with a USB adapter emulator circuit.

The MAX14600–MAX14605 and MAX14618 support passthrough mode and auto mode. In charging downstream port (CDP) pass-through mode, the devices emulate the CDP function while supporting normal USB traffic. The MAX14600/MAX14603/MAX14605 have a pFET open-drain output (CEN), and the MAX14601/MAX14604/MAX14618 have an nFET open-drain output (CEN) to restart the peripheral connected to the USB host.

All the devices support the CDP and standard downstream port (SDP) charging during the active state (S0) and support the dedicated charging port (DCP) charging during the standby state (S3/S4/S5). The MAX14603/ MAX14604/MAX14605/MAX14618 support remote wakeup in standby mode. The MAX14602/MAX14605 offer backward-compatible CDP emulation upgrade to the MAX14566E.

The MAX14600–MAX14605/MAX14618 are available in an 8-pin (2mm x 2mm) TDFN package, and are specified over the  $-40^{\circ}$ C to  $+85^{\circ}$ C extended temperature range.

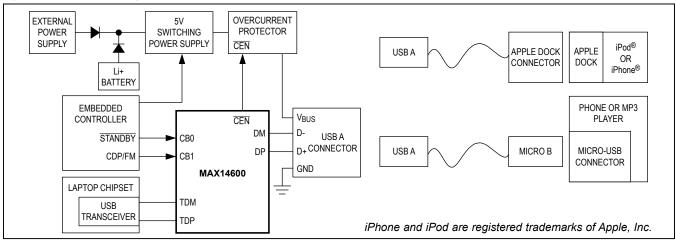
<u>Ordering Information/Selector Guide</u> appears at end of data sheet.

### **Benefits and Features**

- Improved Charger Interoperability
  - USB CDP Emulation in S0 State
  - Meets New USB Battery Charging (BC) Revision 1.2 Specification
  - Backward-Compatible with Previous USB BC Revisions
  - Meets China YD/T1591-2009 Charging Specification
  - Supports Standby Mode Charging for Apple and BC Revision 1.2-Compatible Devices
- Greater User Flexibility
  - CB0 and CB1 Pins Control Multiple Automatic and Manual Charger States
- High Level of Integrated Features
  - Supports Remote Wake-Up (MAX14603/ MAX14604/MAX14605/MAX14618)
  - Low-Capacitance USB 2.0 Hi-Speed Switch to Change Charging Modes
  - Automatic Current-Limit Switch Control
- Save Space on Board
  - 2mm x 2mm, 8-Pin TDFN Package

### **Applications**

- USB Host Data/Chargers including:
  - Laptop and Desktop Computers
  - USB Hubs
  - Flat-Panel Displays with USB
  - Media Players
  - Game Consoles





### Typical Operating Circuit

# USB Host Charger Identification/ Adapter Emulators

### **Absolute Maximum Ratings**

Operating Temperature Range	40°C to +85°C
Junction Temperature	+150°C
Storage Temperature Range	65°C to +150°C
Lead Temperature (soldering, 10s)	+300°C
Soldering Temperature (reflow)	+260°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### Package Thermal Characteristics (Note 1)

TDFN

Junction-to-Ambient Thermal Resistance  $(\theta_{JA})$ .......84°C/W Junction-to-Case Thermal Resistance  $(\theta_{JC})$ ......37°C/W

Note 1: Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to www.maximintegrated.com/thermal-tutorial.

#### **Electrical Characteristics**

(V<sub>CC</sub> = 3.0V to 5.5V,  $T_A = T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted. Typical values are at V<sub>CC</sub> = 5.0V,  $T_A = +25^{\circ}$ C.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
POWER SUPPLY						
Dewer Supply Depag	N	V <sub>CB0</sub> > V <sub>IH</sub> (Note 6)	3.0		5.5	V
Power-Supply Range	V <sub>CC</sub>	V <sub>CB0</sub> = 0V (Note 3)	4.75		5.25	
		$V_{CB0} = V_{CB1} = V_{CC} = 5.25V$ , CM mode		50	100	
		$V_{CB0} = V_{CC} = 5.25$ V, $V_{CB1} = 0$ V, PM mode		4	20	
Supply Current	I <sub>CC</sub>	$V_{CB0}$ = 0V, $V_{CB1}$ = $V_{CC}$ = 5.25V, FM mode		10	50	μA
		$V_{CB0} = 0V, V_{CB1} = V_{CC} = 5.25V (MAX14618)$		130	200	
		$V_{CB0} = V_{CB1} = 0V$ , AM mode		130	200	
ANALOG SWITCH						
Analog-Signal Range	V <sub>DP</sub> , V <sub>DM</sub>		0		V <sub>CC</sub>	V
On-Resistance TDP/TDM Switch	R <sub>ON</sub>	$R_{ON} \qquad V_{TDP} = V_{TDM} = 0V \text{ to } V_{CC}, \\ I_{TDP} = I_{TDM} = 10\text{mA} \qquad 3.5$		3.5	6.5	Ω
On-Resistance Match Between Channels TDP/TDM Switch	$\Delta R_{ON}$	$V_{CC}$ = 5.0V, $V_{DP}$ = $V_{DM}$ = 400mV, $I_{DP}$ = $I_{DM}$ = 10mA		0.1		Ω
On-Resistance Flatness TDP/TDM Switch	R <sub>FLAT</sub>	$V_{CC}$ = 5.0V, $V_{DP}$ = $V_{DM}$ = 0 to $V_{CC}$ , $I_{DP}$ = $I_{DM}$ = 10mA		0.1		Ω
On-Resistance of DP/DM Short	R <sub>SHORT</sub>	$V_{CB0} = 0V, V_{CB1} = V_{CC}, V_{DP} = 1V, R_{DM} = 20k\Omega$		70	120	Ω
Off-Leakage Current	I <sub>TDPOFF,</sub> I <sub>TDMOFF</sub>	$V_{CC} = 3.6V, V_{DP} = V_{DM} = 0.3V$ to 3.3V, $V_{TDP} = V_{TDM} = 3.3V$ to 0.3V	-250		+250	nA
On-Leakage Current	I <sub>DPON</sub> , I <sub>DMON</sub>	$V_{CC} = 3.6V, V_{DP} = V_{DM} = 3.3V \text{ to } 0.3V,$ $V_{CB} = V_{CC}$	-250		+250	nA
DYNAMIC PERFORMANCE (Note	e 4)					
Turn-On Time	t <sub>ON</sub>	$V_{TDP}$ or $V_{TDM}$ = 1.5V, $R_L$ = 300 $\Omega$ , $C_L$ = 35pF, $V_{IH}$ = $V_{CC}$ , $V_{IL}$ = 0V, Figure 1		300	800	μs

# USB Host Charger Identification/ Adapter Emulators

### **Electrical Characteristics (continued)**

(V<sub>CC</sub> = 3.0V to 5.5V, T<sub>A</sub> = T<sub>MIN</sub> to T<sub>MAX</sub>, unless otherwise noted. Typical values are at V<sub>CC</sub> = 5.0V, T<sub>A</sub> = +25°C.) (Note 2)

Turn-Off Time $t_{OFF}$ $V_{TDP} \text{ or } V_{TDM} = 1.5V, R_L = 300\Omega, C_L = 35pF, V_{IH} = V_{CC}, V_{IL} = 0V, Figure 1 (Note 5)TDP, TDM Switch Propagation Delayt_{PLH}, t_{PHL}R_L = R_S = 50\OmegaOutput Skewt_{SK}Skew between DP and DM when connected to TDP and TDM, R_L = R_S = 50\Omega, Figure 2TDP, TDM Off-CapacitanceC_{OFF}f_{SW} = 1MHz, V_{BIAS} = 0V, V_{IN} = 500mV_{P-P}DP, DM On-Capacitance (connected to TDP, TDM)C_{ON}f_{SW} = 240MHz, V_{BIAS} = 0V, V_{IN} = 500mV_{P-P}$	1 60 40 2.0 4.0 1000	5	μs ps ps pF pF
Delay $t_{PLH}$ , $t_{PHL}$ $R_L = R_S = 500^\circ$ Output Skew $t_{SK}$ Skew between DP and DM when connected to TDP and TDM, $R_L = R_S = 50\Omega$ , Figure 2TDP, TDM Off-Capacitance $C_{OFF}$ $f_{SW} = 1MHz$ , $V_{BIAS} = 0V$ , $V_{IN} = 500mV_{P-P}$ DP, DM On-Capacitance $C_{OV}$ $f_{SW} = 240MHz$ , $V_{PAR} = 0V$ , $V_{IN} = 500mV_{P-P}$	40 2.0 4.0 1000	5.5	ps pF
Output Skew $t_{SK}$ connected to TDP and TDM, $R_L = R_S = 50\Omega$ , Figure 2TDP, TDM Off-Capacitance $C_{OFF}$ $f_{SW} = 1MHz$ , $V_{BIAS} = 0V$ , $V_{IN} = 500mV_{P-P}$ DP, DM On-Capacitance $C_{ON}$ $f_{OV} = 240MHz$ , $V_{PVO} = 0V$ , $V_{VN} = 500mV_{P-P}$	2.0 4.0 1000	5.5	pF
DP, DM On-Capacitance $f_{OV} = 240 \text{MHz}$ $V_{DVO} = 0 \text{V} / V_{DV} = 500 \text{m}/p_{DV}$	4.0 1000	5.5	
DP, DM On-Capacitance $f_{OV} = 240 \text{MHz}$ $V_{DVO} = 0 \text{V} / V_{DV} = 500 \text{m}/p_{DV}$	1000	5.5	pF
-3dB Bandwidth BW $R_L = R_S = 50\Omega$			MHz
Off-Isolation $V_{ISO}$ $V_{TDP}$ or $V_{DP} = 0dBm$ , $R_L = R_S = 50\Omega$ , $f_{SW} = 250MHz$ , Figure 3	-20		dB
Crosstalk $V_{CT}$ $V_{TDP}$ or $V_{DP} = 0$ dBm, $R_L = R_S = 50\Omega$ , $f_{SW} = 250$ MHz, Figure 3	-25		dB
DPC INTERNAL RESISTORS			•
DP/DM Short Pulldown R <sub>PD</sub> 320	500	730	kΩ
RP1/RP2 Ratio RT <sub>RP</sub> 1.4	1.5	1.55	_
RP1 + RP2 Resistance R <sub>RP</sub> 85	125	170	kΩ
RM1/RM2 Ratio RT <sub>RM</sub> 0.85	0.86	0.87	_
RM1 + RM2 Resistance R <sub>RM</sub> 60	93	125	kΩ
DPC COMPARATORS (Note 4)			
DM1 Comparator Threshold V <sub>DM1F</sub> DM falling 40	41	42	%V <sub>CC</sub>
DM1 Comparator Hysteresis	1		%
DM2 Comparator Threshold V <sub>DM2F</sub> DM falling 6.31	7	7.6	%V <sub>CC</sub>
DM2 Comparator Hysteresis	1		%
DP Comparator Threshold V <sub>DPR</sub> DP rising 45	46	47	%V <sub>CC</sub>
DP Comparator Hysteresis	1		%
CDP INTERNAL RESISTORS			
DP Pulldown Resistor R <sub>DP_DWN</sub>	14.25	24.8	kΩ
DM Pulldown Resistor R <sub>DM_DWN</sub>	14.25	24.8	kΩ
CDP LOW-SPEED COMPARATORS			
$V_{DM\_SRC}$ Voltage $V_{DM\_SRC}$ $I_{LOAD} = 0$ to 200µA 0.5		0.7	V
V <sub>DAT_REF</sub> Voltage V <sub>DAT_REF</sub> 0.25		0.4	V
V <sub>LGC</sub> Voltage V <sub>LGC</sub> 0.8		2.0	V
$I_{DP\_SINK}$ Current $I_{DP\_SINK}$ $V_{DP} = 0.15V$ to 3.6V 50		150	μA

# USB Host Charger Identification/ Adapter Emulators

### **Electrical Characteristics (continued)**

(V<sub>CC</sub> = 3.0V to 5.5V, T<sub>A</sub> = T<sub>MIN</sub> to T<sub>MAX</sub>, unless otherwise noted. Typical values are at V<sub>CC</sub> = 5.0V, T<sub>A</sub> = +25°C.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
LOGIC INPUTS (CB0, CB1)			•			
CB0/CB1 Input Logic-High	V <sub>IH</sub>		1.4			V
CB0/CB1 Input Logic-Low	VIL				0.4	V
CB0/CB1 Input Leakage Current	I <sub>IN</sub>	$V_{CC} = 5.5V, 0V \le V_{IN} \le V_{IL} \text{ or}$ $V_{IH} \le V_{IN} \le V_{CC}$	-1		+1	μA
CEN/CEN OUTPUTS						
V <sub>BUS</sub> Toggle Time	t <sub>VBT</sub>	CB0 = $V_{IL}$ to $V_{IH}$ or $V_{IH}$ to $V_{IL}$	1	2	3	s
CEN Output Logic-High Voltage		CB0 = $V_{IL}$ to $V_{IH}$ , $I_{SOURCE}$ = 2mA	V <sub>CC</sub> - 0.4			v
CEN Output Leakage Current		$V_{CC}$ = 5.5V, $V_{\overline{CEN}}$ = 0V, $\overline{CEN}$ deasserted			1	μA
CEN Output Logic-Low Voltage		CB0 = $V_{IL}$ to $V_{IH}$ , $I_{SINK}$ = 2mA			0.4	V
CEN Output Leakage Current		$V_{CC}$ = $V_{CEN}$ = 5.5V, CEN deasserted			1	μA
ESD PROTECTION						
ESD Protection Level	V <sub>ESD</sub>	НВМ		±2		kV

**Note 2:** All units are 100% production tested at  $T_A = +25^{\circ}C$ . Specifications over temperature are guaranteed by design.

**Note 3:** The device is operational from 3.0V to 5.5V. However, to have the valid Apple resistor-divider network, the V<sub>CC</sub> supply must stay within 4.75V to 5.25V.

Note 4: Guaranteed by design.

Note 5: Does not include the delay by the state machine.

Note 6: For BC1.2 CDP compliance,  $V_{CC,MIN}$  = 4.75V,  $V_{CC,MAX}$  = 5.25V.

### **Test Circuits/Timing Diagrams**

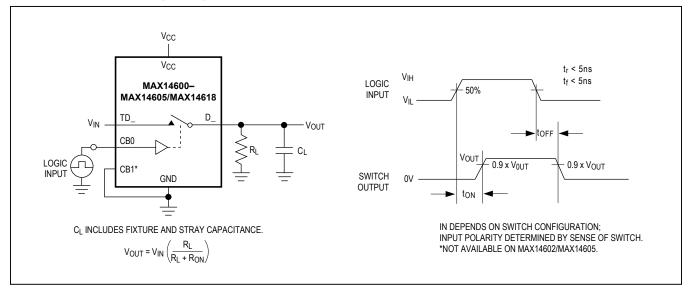


Figure 1. Switching Time

# USB Host Charger Identification/ Adapter Emulators

### **Test Circuits/Timing Diagrams (continued)**

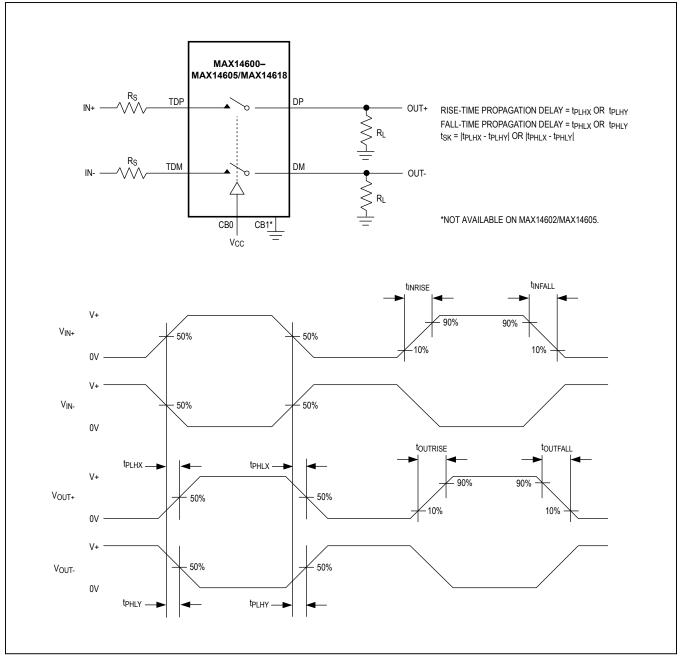


Figure 2. Output Signal Skew

# USB Host Charger Identification/ Adapter Emulators

### **Test Circuits/Timing Diagrams (continued)**

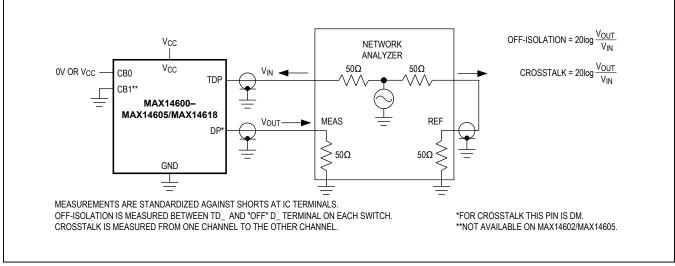
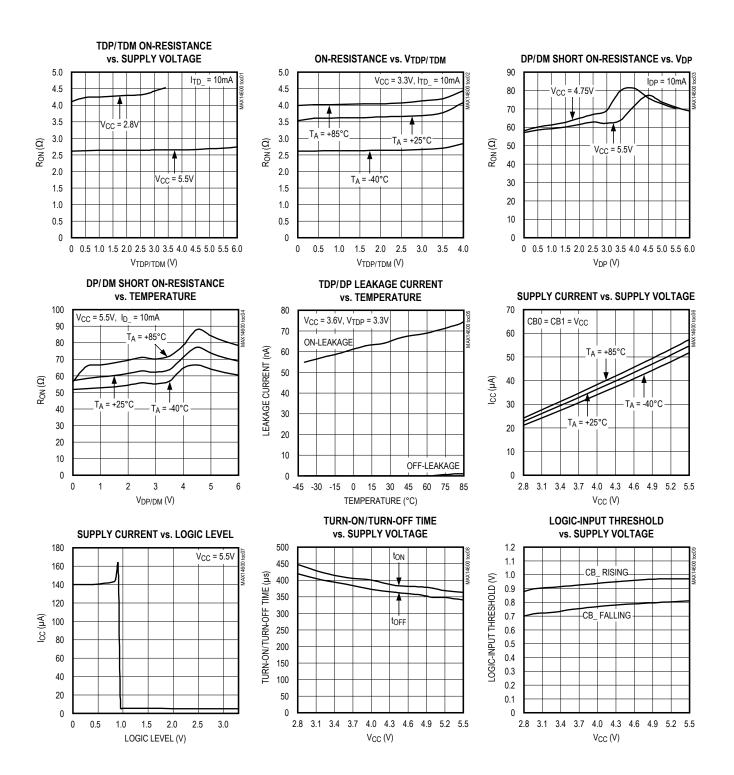


Figure 3. Off-Isolation and Crosstalk

# USB Host Charger Identification/ Adapter Emulators

### **Typical Operating Characteristics**

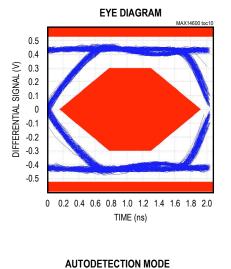
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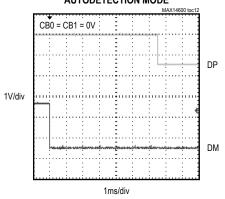


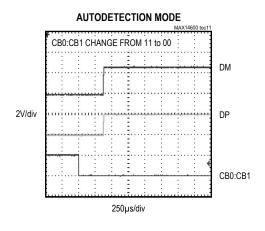
# USB Host Charger Identification/ Adapter Emulators

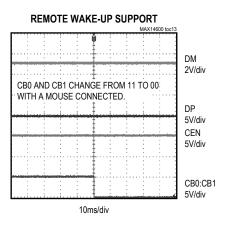
### **Typical Operating Characteristics (continued)**

(T<sub>A</sub> = +25°C, unless otherwise noted.)



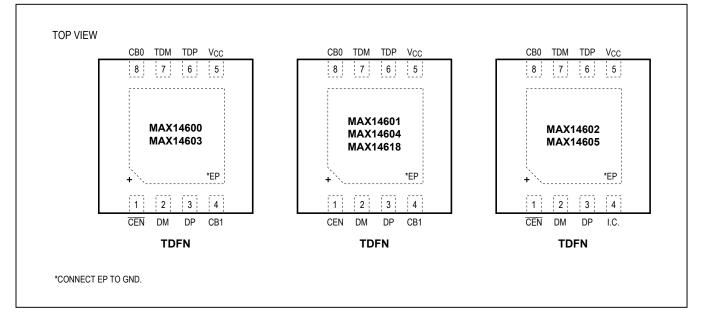






# USB Host Charger Identification/ Adapter Emulators

# **Pin Configurations**

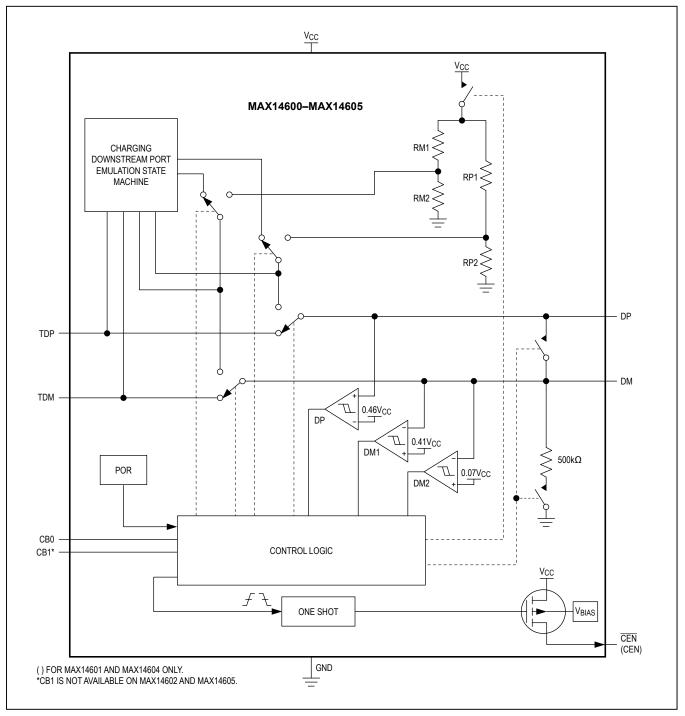


### **Pin Descriptions**

	PIN				
MAX14600/ MAX14603	MAX14601/ MAX14604/ MAX14618	MAX14602/ MAX14605	NAME	FUNCTION	
1	_	1	CEN	Active-Low pMOSFET Open-Drain Output, Current-Limit Switch (CLS) Control Output. When CB0 changes from V <sub>IL</sub> to V <sub>IH</sub> or V <sub>IH</sub> to V <sub>IL</sub> , $\overline{CEN}$ is high.	
_	1		CEN	nMOSFET Open-Drain Output, CLS Control Output. When CB0 changes from V <sub>IL</sub> to V <sub>IH</sub> or from V <sub>IH</sub> to V <sub>IL</sub> , CEN is low.	
2	2	2	DM	USB Connector D- Connection	
3	3	3	DP	USB Connector D+ Connection	
4	4	—	CB1	Switch Control Bit. See Table 1.	
—	—	4	I.C.	Internally Connected. Do not externally connect.	
5	5	5	V <sub>CC</sub>	Power Supply. Connect a $0.1\mu F$ capacitor between $V_{CC}$ and ground as close as possible to the device.	
6	6	6	TDP	Host USB Transceiver D+ Connection	
7	7	7	TDM	Host USB Transceiver D- Connection	
8	8	8	CB0	Switch Control Bit. See Table 1.	
	_		EP	Exposed Pad. Connect EP to ground. For enhanced thermal dissipation, connect EP to a copper area as large as possible.	

# USB Host Charger Identification/ Adapter Emulators

# **Functional Diagram**



### **Detailed Description**

The MAX14600–MAX14605 and MAX14618 adapter emulator family has Hi-Speed USB analog switches that support USB hosts to identify the USB port as a charger port when the USB host is in a low-power mode and cannot enumerate USB devices. These Hi-Speed USB switches feature low 4pF (typ) on-capacitance and low  $3.5\Omega$  (typ) on-resistance. DP and DM can handle signals between 0V and 6V with any supply voltage.

#### **Resistor-Dividers**

The MAX14600–MAX14605/MAX14618 family features an internal resistor-divider for biasing data lines to provide support for Apple-compliant devices. When the MAX14600–MAX14605/MAX14618 family is not operated with the resistor-divider, the device disconnects the resistor-dividers from the supply voltage to minimize supply current requirements. The resistor-dividers are not connected in pass-through mode.

#### **Switch Control**

The MAX14600–MAX14605/MAX14618 family features dual digital inputs, CB0 and CB1, for mode selection.

For the MAX14600/MAX14601/MAX14603/MAX14604, connect CB0 and CB1 to a logic-level low voltage for autodetection charger mode (AM). Change only CB1 to a logic-level high for forced dedicated charger mode (FM). Change only CB1 to a logic-level low for normal high-speed pass-through mode (PM). Connect CB0 and CB1 to a logic-level high for high-speed pass-through mode with CDP emulation (CM). See Table 1.

For the MAX14618, connect CB0 to a logic-level low voltage for autodetection charger mode (AM). Change CB0 to a logic-level high voltage and CB1 to a logic-level low voltage to place the MAX14618 in normal high-speed pass-through charger mode (PM). Connect CB0 and CB1 to a logiclevel high for high-speed pass-through mode with CDP emuation (CM). See <u>Table 2</u>.

#### Table 1. Digital Input State for MAX14600/MAX14601/MAX14603/MAX14604

CB0	CB1	CHARGER/USB	MODE	STATUS
0	0	Charger	AM	Autodetection Charger Mode
0	1	Charger	FM	Force Dedicated Charger Mode: DP/DM shorted.
1	0	USB	PM	USB Pass-Through Mode: DP/DM connected to TDP/TDM.
1	1	USB	СМ	USB Pass-Through Mode with CDP Emulation: Auto connects DP/DM to TDP/TDM depending on CDP status.

#### Table 2. Digital Input State for MAX14618

CB0	CB1	CHARGER/USB	MODE	STATUS
0	Х	Charger	AM	Auto detection Charger Mode with Remote Wake-Up
1	0	USB	PM USB Pass-Through Mode: DP/DM connected to TDP/TDM.	
1	1	USB	СМ	USB Pass-Through Mode with CDP Emulation: Auto connects DP/DM to TDP/TDM depending on CDP status.

#### Table 3. Digital Input State for MAX14602/MAX14605

CB0	CHARGER/USB	MODE	STATUS
0	Charger	AM	Autodetection Charger Mode
1	USB	СМ	USB Pass-Through Mode with CDP Emulation: Auto connects DP/DM to TDP/TDM depending on CDP status.

In CDP emulation mode, the peripheral device with CDP detection capability draws the charging current up to 1.5A immediately without USB enumeration. The MAX14602/MAX14605 have CB0 digital input control only (Table 3). The MAX14602/MAX14605 are pin-to-pin compatible with the MAX14566E, and CB0 and CB1 are connected together internally, which makes these devices easy upgrades for CDP emulation.

#### Autodetection

The MAX14600–MAX14605/MAX14618 family features autodetection charger mode for dedicated chargers and USB masters. Both CB0 and CB1 must be set low to activate autodetection charger mode.

In autodetection charger mode, the device monitors the voltages at DM and DP to determine the type of device attached. If the voltage at DM is 2.05V (typ) or higher and the voltage at DP is 2.3V (typ) or lower, the voltage stays unchanged. If the voltage at DM is forced below the 2.05V (typ) threshold, the internal switch disconnects DM and

DP from the resistor-divider and DP and DM are shorted together for dedicated charging mode.

Also, if the voltage at DP is forced higher than the 2.3V (typ) threshold, the internal switch disconnects DM and DP from the resistor-divider and DP and DM are shorted together for dedicated charging mode.

Once the charging voltage is removed, the short between DP and DM is disconnected for normal operation.

#### **Auto-Peripheral Reset**

The MAX14600–MAX14605/MAX14618 family features an auto current-limit switch-control output. This feature resets the peripheral connected to  $V_{BUS}$  in the event the USB host switches to or from standby mode. CEN or CEN provide a 2s (typ) pulse on the rising or falling-edge of CB0 (Figure 4 and Figure 5.) With the MAX14603/ MAX14604/MAX14605/MAX14618, the autoperipheral reset is suspended in case of CB0 and CB1 transition from 11 to 00 as long as the peripheral remains connected. See the <u>Remote Wake-Up Support</u> section for more information.

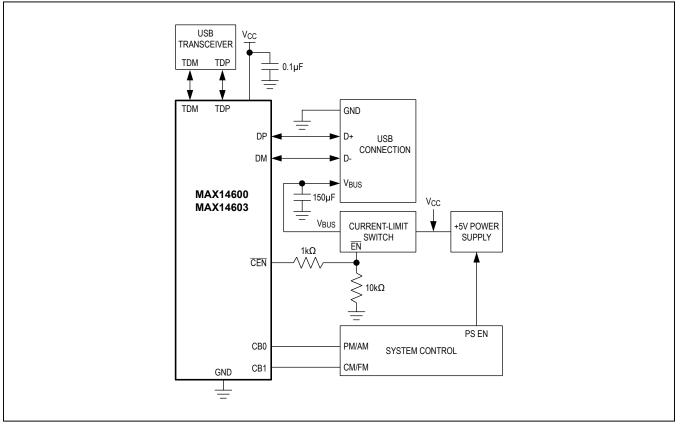


Figure 4. MAX14600/MAX14603 Peripheral Reset Applications Diagram

# USB Host Charger Identification/ Adapter Emulators

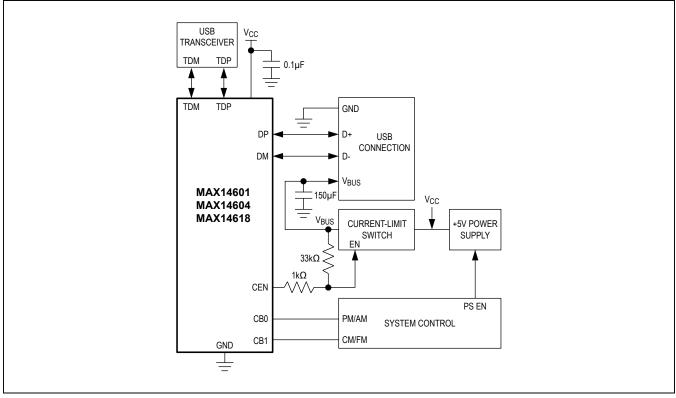


Figure 5. MAX14601/MAX14604/MAX14618 Peripheral Reset Applications Diagram

#### **Table 4. Different Power States**

STATE	DESCRIPTION
S0	System on.
S1	Power to the CPU(s) and RAM is maintained; devices that do not indicate they must remain on can be powered down.
S2	CPU is powered off.
S3	Standby (suspend to RAM). System memory context is maintained, and all other system context is lost.
S4	Hibernate. Platform context is maintained.
S5	Soft off.

#### **USB Pass-Through Mode with CDP Emulation**

The MAX14600–MAX14605/MAX14618 family features a pass-through mode with CDP emulation. This is to support the higher charging current capability during the pass-through mode in normal USB operation (S0 state). The peripheral device equipped with CDP detection capability could draw a charging current as defined in USB Battery Charger Specification 1.2 when the charging host supports the CDP mode. This is a useful feature since most host USB transceivers do not have the CDP function. Table 4 shows the different power states of S0–S5.

#### **Bus Voltage Discharge**

The MAX14601/MAX14604/MAX14618 auto current-limit switch-control output can be used to discharge the V<sub>BUS</sub> during V<sub>BUS</sub> reset. When the system controls the current limit switch for V<sub>BUS</sub> toggle, the output capacitor can be discharged slowly depending upon the load. If fast discharge of the V<sub>BUS</sub> is desired, the CEN output can be used to discharge the V<sub>BUS</sub> (Figure 6.)

#### **Data Contact Detect Support**

The MAX14600–MAX14605/MAX14618 family support USB devices that require detecting the USB data lines prior to charging. When a USB Revision 1.2-compliant device is attached, the USB data lines DP and DM are shorted together. The short remains until it is detected by the USB device. This feature guarantees appropriate charger detection if a USB Revision 1.2-compliant device is attached. The autodetection charger mode is activated after the data contact detect is established. CB0 and CB1 must be set low to activate data contact detect support.

#### **Remote Wake-Up Support**

The MAX14603/MAX14604/MAX14605/MAX14618 feature remote wake-up if pass-through mode with CDP emulation is used prior to transitioning to auto mode in standby state (S3). If the peripheral device is connected and remains in the USB port during S0 state, the MAX14603/ MAX14604/MAX14605/MAX14618 maintain the passthrough mode until it is removed. If this feature is not needed, such as in battery-powered mode, the embedded control could cancel the remote wake-up by toggling the V<sub>BUS</sub> as it moves into the standby state.

#### **Backward Compatibility**

The MAX14602/MAX14605 offer easy backward-compatible CDP emulation upgrade to the MAX14566E.

#### **ESD Test Conditions**

ESD performance depends on a variety of conditions. Contact Maxim for a reliability report that documents test methodology and results.

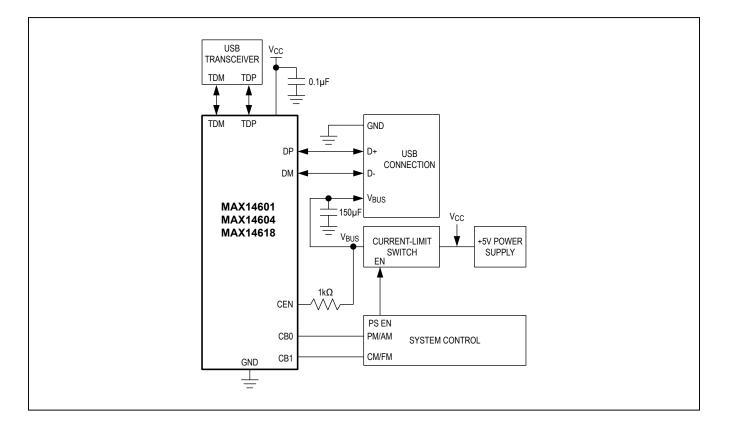


Figure 6. MAX14601/MAX14604/MAX14618 VBUS Discharge Circuit

# USB Host Charger Identification/ Adapter Emulators

# Extended ESD Protection (Human Body Model)

ESD-protection structures are incorporated on all pins to protect against electrostatic discharges up to  $\pm 2kV$ 

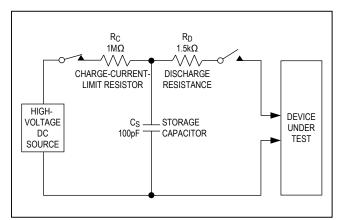


Figure 7a. Human Body ESD Test Model

(Human Body Model) encountered during handling and assembly. The ESD structures withstand high ESD both in normal operation and when the device is powered down. After an ESD event, the device continues to function without latchup (Figure 7a and Figure 7b).

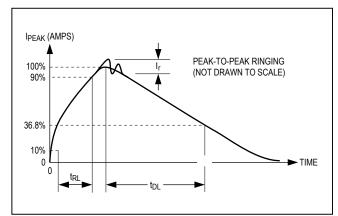


Figure 7b. Human Body Current Waveform

# Ordering Information/Selector Guide

PART	TEMP RANGE	MODE CONTROL	CLS CONTROL	REMOTE WAKE-UP	PIN-PACKAGE
MAX14600ETA+T	-40°C to +85°C	CB0, CB1	CEN	No	8 TDFN-EP*
MAX14601ETA+T**	-40°C to +85°C	CB0, CB1	CEN	No	8 TDFN-EP*
MAX14602ETA+T	-40°C to +85°C	CB0	CEN	No	8 TDFN-EP*
MAX14603ETA+T**	-40°C to +85°C	CB0, CB1	CEN	Yes	8 TDFN-EP*
MAX14604ETA+T	-40°C to +85°C	CB0, CB1	CEN	Yes	8 TDFN-EP*
MAX14605ETA+T**	-40°C to +85°C	CB0	CEN	Yes	8 TDFN-EP*
MAX14618ETA+T†	-40°C to +85°C	CB0, CB1	CEN	Yes	8 TDFN-EP*

+Denotes a lead(Pb)-free/RoHS-compliant package.

T = Tape and reel.

\*EP = Exposed pad.

\*\*Future product—contact factory for availability. †Refer to Table 2 for differences in digital input.

### **Chip Information**

PROCESS: BICMOS

### **Package Information**

For the latest package outline information and land patterns (footprints), go to <u>www.maximintegrated.com/packages</u>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE	PACKAGE	OUTLINE	LAND
TYPE	CODE	NO.	PATTERN NO.
8 TDFN-EP	T822+2	<u>21-0168</u>	<u>90-0065</u>

# USB Host Charger Identification/ Adapter Emulators

### **Revision History**

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	6/11	Initial release	—
1	9/11	Added MAX14618 to data sheet; corrected Conditions on V <sub>DM_SRC</sub> Voltage in the <i>Electrical Characteristics</i> ; corrected x-scale labels on TOC5 in the <i>Typical Operating Characteristics</i>	1–7, 9, 11–15
2	10/11	Corrected package code and land pattern number in the Package Information	15
3	5/12	Relabeled TOC 10	9
4	2/16	Added Note 6 to Electrical Characteristics table	2, 3

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